

November 1991

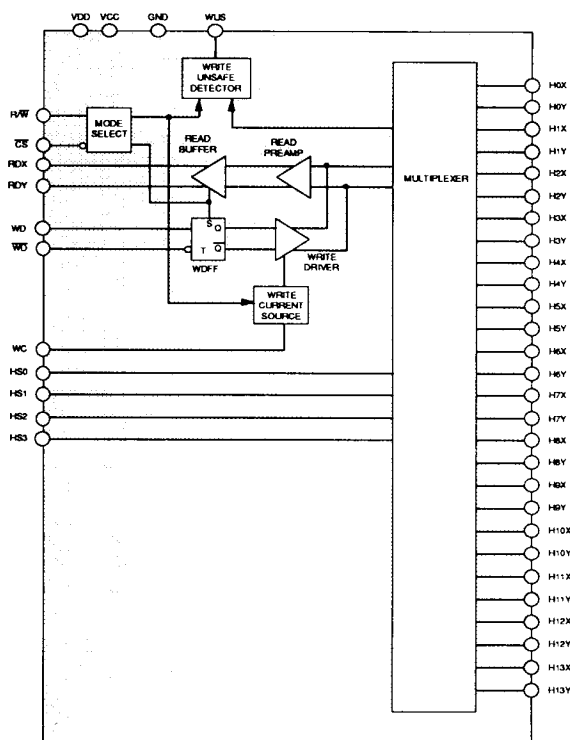
DESCRIPTION

The SSI 32R5281R Read/Write device is a bipolar monolithic integrated circuit designed for use with two-terminal thin-film recording heads. It provides a low noise read amplifier, write current control and data protection circuitry for up to 14 channels. Power supply fault protection is provided by disabling the write current generator during power sequencing. System write to read recovery time is significantly improved by controlling the read channel common mode output voltage shift in the write mode. It requires +5V and +12V power supplies and provides internal 700Ω damping resistors.

FEATURES

- High performance:
Read mode gain = 250 V/V
Input noise = 0.85 nV/√Hz max.
Input capacitance = 35 pF max.
Write current range = 10 mA to 40 mA
Head voltage swing = 7 Vpp
Write current rise time = 9 ns
- Enhanced system write to read recovery time
- Differential ECL-like Write Data Input
- Power supply fault protection
- Write unsafe detection
- +5V, +12V power supplies

BLOCK DIAGRAM



PIN DIAGRAM

H0X	1	44	H13Y
H0Y	2	43	H13X
H1X	3	42	GND
H1Y	4	41	HS3
H2X	5	40	CS
H2Y	6	39	R/W
H3X	7	38	WC
H3Y	8	37	RDY
H4X	9	36	RDY
H4Y	10	35	HS0
H5X	11	34	HS1
H5Y	12	33	HS2
H6X	13	32	VCC
H6Y	14	31	WD
H7X	15	30	WD
H7Y	16	29	WUS
H8X	17	28	GND
H8Y	18	27	VDD
H9X	19	26	H12Y
H9Y	20	25	H12X
H10X	21	24	H11Y
H10Y	22	23	H11X

44-LEAD SOM

CAUTION: Use handling procedures necessary for a static sensitive component.

SSI 32R5281R

14-Channel Two-Terminal Read/Write Device

CIRCUIT OPERATION

The SSI 32R5281R addresses up to 14 two-terminal thin film heads providing write drive or read amplification. Head selection and mode control is accomplished with pins HSn, \overline{CS} and R/\overline{W} , as shown in Tables 1 & 2. Internal resistor pullups, provided on pins \overline{CS} and R/\overline{W} will force the device into a non-writing condition if either control line is opened accidentally.

WRITE MODE

The write mode configures the SSI 32R5281R as a current switch and activates the Write Unsafe (WUS) detection circuitry. Write current is toggled between the X and Y direction of the selected head on each low to high transition on the WD, Write Data input. (See figure 1.)

A preceding read operation initializes the Write Data Flip Flop (WDFF) to pass write current in the X-direction of the head, i.e., into the X-port.

The magnitude of the write current (0-pk) is given by:

$$I_w = \frac{V_{wc}}{R_{wc}}$$

where V_{wc} (WC pin voltage) = $1.65V \pm 5\%$, is programmed by an external resistor R_{wc} , connected from pin WC to ground. In multiple device applications, a single R_{wc} resistor may be made common to all devices. The actual head current I_x, y is given by:

$$I_x, y = \frac{I_w}{1 + R_h/R_d}$$

where:

R_h = head resistance + external wire resistance, and
 R_d = damping resistance.

Power supply fault protection improves data security by disabling the write current generator during a voltage fault or power supply sequencing. Additionally, the write unsafe detection circuitry will flag any of the conditions listed below as a high level on the open collector output pin, WUS. Two positive transitions on the WD, Write Data input line, after the fault is corrected, are required to clear the WUS flag.

- WD frequency too low
- Device in read mode
- Device not selected
- No write current
- Open head

READ MODE

The read mode configures the SSI 32R5281R as a low noise differential amplifier and deactivates the write current generator and write unsafe detection circuitry. The RDX and RDY outputs are emitter followers and are in phase with the "X" and "Y" head ports. These outputs should be AC coupled to the load. The RDX, RDY common mode voltage is maintained at the write mode value, minimizing the transient between write mode and read mode, substantially reducing the write to read recovery time in the subsequent Pulse Detection circuitry.

IDLE MODE

The idle mode deactivates the internal write current generator, the write unsafe detector and switches the RDX, RDY outputs into a high impedance state. This facilitates multiple device applications by enabling the read outputs to be wire-OR'ed and the write current programming resistor to be common to all devices.

TABLE 1: Mode Select

\overline{CS}	R/\overline{W}	MODE
0	0	Write
0	1	Read
1	0	Idle
1	1	Idle

TABLE 2: Head Select

HS3	HS2	HS1	HS0	HEAD
0	0	0	0	0
0	0	0	1	1
0	0	1	0	2
0	0	1	1	3
0	1	0	0	4
0	1	0	1	5
0	1	1	0	6
0	1	1	1	7
1	0	0	0	8
1	0	0	1	9
1	0	1	0	10
1	0	1	1	11
1	1	0	0	12
1	1	0	1	13

0 = Low level

1 = High level

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PIN DESCRIPTION

NAME	TYPE	DESCRIPTION
HSO - HS3	I	Head Select
\overline{CS}	I	Chip Select: a low level enables the device
R/W	I	Read/Write: a high level selects Read mode
WUS	O*	Write Unsafe: Open collector output, a high level indicates an unsafe writing condition
WD, \overline{WD}	I	Differential Write Data inputs: a positive transition on WD toggles the direction of the head current
H0X - H13X H0Y - H13Y	I/O	X, Y Head Connections: Current in the X-direction flows into the X-port
RDX, RDY	O*	X, Y Read Data: differential read data output
WC	*	Write Current: used to set the magnitude of the write current
VCC	-	+5V Logic Circuit Supply
VDD	-	+12V
GND	-	Ground

*When more than one R/W device is used, these signals can be wire OR'ed.

ELECTRICAL SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS

Operation outside these rating limits may permanently damage the device.

PARAMETER		SYMBOL	VALUE	UNITS
DC Supply Voltage		VDD	-0.3 to +14	VDC
		VCC	-0.3 to +7	VDC
Write Current		I _w	100	mA
Digital Input Voltage		V _{in}	-0.3 to VCC +0.3	VDC
Head Port Voltage		V _H	-0.3 to VDD2 +0.3	VDC
WUS Pin Voltage Range		V _{wus}	-0.3 to +14	VDC
Output Current	RDX, RDY	I _o	-10	mA
	WUS	I _{wus}	+12	mA
Storage Temperature		T _{stg}	-65 to +150	°C

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RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNITS
DC Supply Voltage	VDD	$12 \pm 10\%$	VDC
	VCC	$5 \pm 10\%$	VDC
Operating Temperature	Tj	+25 to +135	°C

DC CHARACTERISTICS

Unless otherwise specified, recommended operating conditions apply.

PARAMETER	CONDITIONS	MIN	NOM	MAX	UNITS
VDD Supply Current	Read Mode	-	30	TBD	mA
	Write Mode	-	39	TBD	mA
	Idle Mode	-	12	TBD	mA
VCC Supply Current	Read Mode	-	50	TBD	mA
	Write Mode	-	32	TBD	mA
	Idle Mode	-	43	TBD	mA
Power Dissipation (Tj = +135°C)	Read Mode	-	-	800	mW
	Write Mode: Iw = 20 mA,	-	-	1000	mW
	Idle Mode	-	360	570	mW
WD, $\overline{\text{WD}}$ Input Low Current (IIL1)	VIL1 = VCC -1.625V			80	μA
WD, $\overline{\text{WD}}$ Input High Current (IIH1)	VIH1 = VCC -0.72V			100	μA
WD, $\overline{\text{WD}}$ Input Low Voltage (VIL1)		VCC -1.870		VCC -1.625	VDC
WD, $\overline{\text{WD}}$ Input High Voltage (VIH1)		VCC -1.00		VCC -0.720	VDC
R/ $\overline{\text{W}}$, $\overline{\text{CS}}$, HS0-HS3 Input Low Current (IIL2)	VIL2 = 0.8V	-0.4			mA
R/ $\overline{\text{W}}$, $\overline{\text{CS}}$, HS0-HS3 Input High Current (IIH2)	VIH2 = 2.0V			100	μA
R/ $\overline{\text{W}}$, $\overline{\text{CS}}$, HS0-HS3 Input Low Voltage (VIL2)				0.8	VDC
R/ $\overline{\text{W}}$, $\overline{\text{CS}}$, HS0-HS3 Input High Voltage (VIH2)		2.0			VDC
WUS Output Low Voltage (VOL)	Iol = 8 mA	-	-	0.5	VDC
VDD Fault Voltage		8.5	-	10.0	VDC
VCC Fault Voltage		3.5	-	4.2	VDC

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DC CHARACTERISTICS (continued)

PARAMETER	CONDITIONS	MIN	NOM	MAX	UNITS
Head Current (HnX, HnY)	Write Mode, $0 \leq VCC \leq 3.5V$ $0 \leq VDD1 \leq 8.5V$	-200	-	+200	μA
	Read/Idle Mode, $0 \leq VCC \leq 5.5V$ $0 \leq VDD1 \leq 13.2V$	-200	-	+200	μA

WRITE CHARACTERISTICS

Unless otherwise specified, recommended operating conditions apply, $I_w = 20 \text{ mA}$, $L_h = 500 \text{ nH}$, $R_h = 30 \Omega$ and $f(WD) = 5 \text{ MHz}$.

WC Pin Voltage (Vwc)		-	1.65 \pm 5%	-	V
Differential Head Voltage Swing	$I_w = 40 \text{ mA}$	7	-	-	Vpp
Unselected Head Current		-	-	1	mA(pk)
Differential Output Capacitance		-	-	25	pF
Differential Output Resistance		500	700	950	Ω
WDI Transition Frequency	WUS = low	1.7	-	-	MHz
	WUS = high	-	-	500	kHz
Write Current Range		10	-	40	mA

READ CHARACTERISTICS

Unless otherwise specified, recommended operating conditions apply $C_L (RDX, RDY) < 20 \text{ pF}$ and $R_L (RDX, RDY) = 1 \text{ k}\Omega$.

PARAMETER	CONDITIONS	MIN	NOM	MAX	UNITS
Differential Voltage Gain	$V_{in} = 1 \text{ mVpp}$ @ 300 kHz	210	250	290	V/V
Bandwidth	-1dB $ Z_s < 5\Omega$, $V_{in} = 1 \text{ mVpp}$	25	40	-	MHz
	-3dB $ Z_s < 5\Omega$, $V_{in} = 1 \text{ mVpp}$	35	55	-	MHz
Input Noise Voltage	$BW = 15 \text{ MHz}$, $L_h = 0$, $R_h = 0$	-	0.62	0.85	nV/ $\sqrt{\text{Hz}}$
Differential Input Capacitance	$V_{in} = 1 \text{ mVpp}$, $f = 5 \text{ MHz}$	-	-	35	pF
Differential Input Resistance	$V_{in} = 1 \text{ mVpp}$, $f = 5 \text{ MHz}$	300	-	-	Ω
Dynamic Range	Peak-to-peak AC input voltage where gain falls to 90% of its small signal value, $f = 5 \text{ MHz}$	2.0	-	-	mVpp
Common Mode Rejection Ratio	$V_{in} = 0 \text{ VDC} + 100 \text{ mVpp}$ @ 5 MHz	54	-	-	dB
Power Supply Rejection Ratio	100 mVpp @ 5 MHz on VDD1 100 mVpp @ 5 MHz on VCC	54	-	-	dB
Channel Separation	Unselected channels driven with 100 mVpp @ 5 MHz, $V_{in} = 0 \text{ mVpp}$	45	-	-	dB

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READ CHARACTERISTICS (continued)

PARAMETER	CONDITIONS	MIN	NOM	MAX	UNITS
Output Offset Voltage		-400	-	+400	mV
RDX, RDY Common Mode Output Voltage	Read Mode or Write Mode	V _{cc} -2.5	V _{cc} - 2.1	V _{cc} -1.7	VDC
Single Ended Output Resistance	f = 5 MHz	-	-	30	Ω
Output Current	AC Coupled Load, RDX to RDY	3.2	-	-	mA

SWITCHING CHARACTERISTICS (See Figure 1)

Unless otherwise specified, recommended operating conditions apply, I_w = 20 mA, L_h = 500 nH, R_h = 30Ω and f(WD) = 5 MHz.

PARAMETER	CONDITIONS	MIN	MAX	UNITS
R/W				
R/W to Write Mode	Delay to 90% of write current	-	0.6	μs
R/W to Read Mode	Delay to 90% of 100mV 10MHz Read signal envelope or to 90% decay of write current	-	0.6	μs
CS				
CS to Select	Delay to 90% of write current or to 90% of 100mV 10MHz Read signal envelope	-	0.6	μs
CS to Unselect	Delay to 90% of write current	-	0.6	μs
HSn				
HS0, 1, 2, 3 to any Head	Delay to 90 % of 100mV 10MHz Read signal envelope	-	0.4	μs
WUS				
Safe to Unsafe - TD1		0.6	3.0	μs
Unsafe to Safe - TD2		-	1	μs
Head Current				
Prop. Delay - TD3	From 50 % points, L _h =0μh, R _h =0Ω	-	32	ns
Asymmetry	WD has 50 % duty cycle and 1ns rise/fall time, L _h =0μh, R _h =0Ω	-	0.5	ns
Rise/Fall Time	10% - 90% points, L _h =0μh, R _h =0Ω	-	9	ns

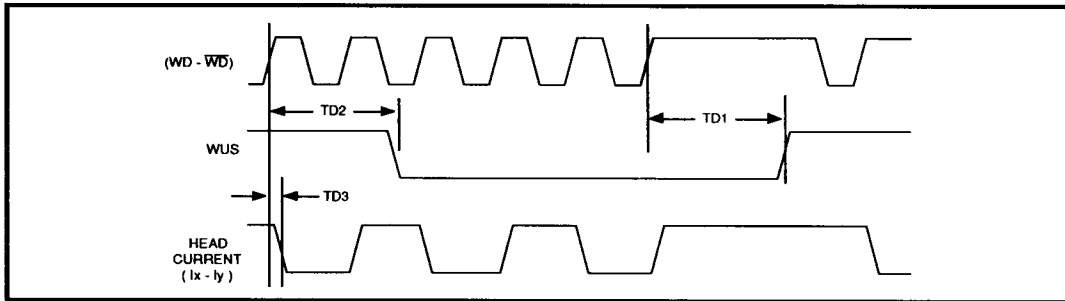


FIGURE 1: Write Mode Timing Diagram

APPLICATIONS INFORMATION

The specifications, provided in the data section, account for the worst case values of each parameter taken individually. In actual operation, the effects of worst case conditions on many parameters correlate. Tables 3 & 4 demonstrate this for several key parameters. Notice that under the conditions of worst case input noise, the higher read back signal resulting from the higher input impedance can compensate for the higher input noise. Accounting for this correlation in your analysis will be more representative of actual performance.

TABLE 3: Key Parameters Under Worst Case Input Noise Conditions

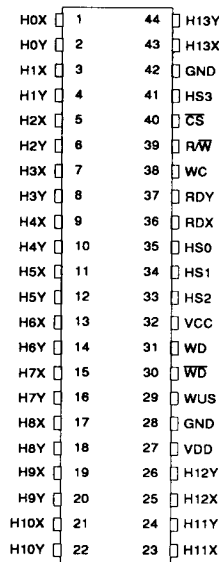
PARAMETER	T _j = 25°C	T _j = 135°C	UNITS
Input Noise Voltage (Max.)	0.70	0.85	nV/√Hz
Differential Input Resistance (Min.)	390	420	Ω
Differential Input Capacitance (Max.)	32	34	pF

TABLE 4: Key Parameters Under Worst Case Input Impedance Conditions

PARAMETER	T _j = 25°C	T _j = 135°C	UNITS
Input Noise Voltage (Max.)	0.58	0.71	nV/√Hz
Differential Input Resistance (Min.)	310	350	Ω
Differential Input Capacitance (Max.)	33	35	pF

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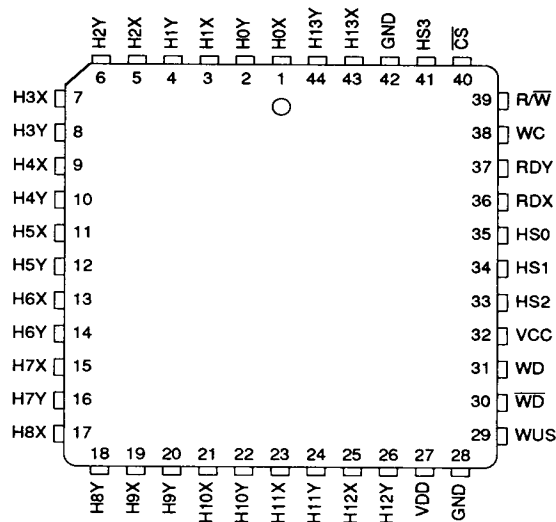
PACKAGE PIN DESIGNATIONS
(Top View)



44-Lead SOM

THERMAL CHARACTERISTICS: θ_{ja}

44-Lead SOM	50°C/W
44-PLCC	60°C/W



44-Pin PLCC

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